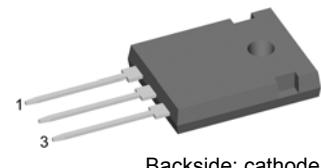
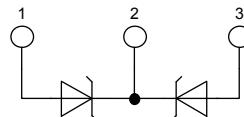


## Schottky Diode

High Performance Schottky Diode  
Low Loss and Soft Recovery  
Common Cathode

Part number

DSA 90 C 200 HB



Backside: cathode

### Features / Advantages:

- Very low  $V_f$
- Extremely low switching losses
- low  $I_{rm}$  values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

### Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

### Package:

- Housing: TO-247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

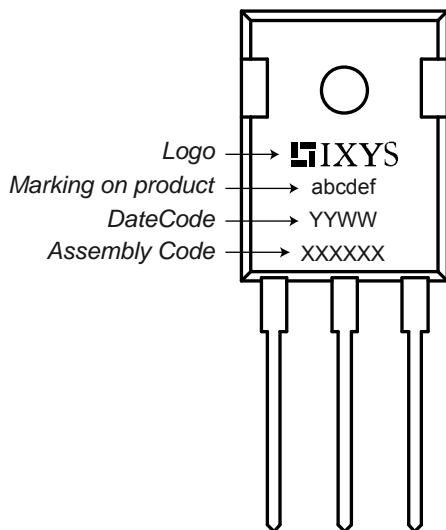
Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ\text{C}$			200	V
$I_R$	reverse current	$V_R = 200\text{V}$ $V_R = 200\text{V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.9 5	mA mA
$V_F$	forward voltage	$I_F = 45\text{A}$ $I_F = 90\text{A}$ $I_F = 45\text{A}$ $I_F = 90\text{A}$	$T_{VJ} = 25^\circ\text{C}$  $T_{VJ} = 125^\circ\text{C}$		0.96 1.18 0.86 1.14	V V V V
$I_{FAV}$	average forward current	rectangular, $d = 0.5$	$T_C = 145^\circ\text{C}$		45	A
$V_{F0}$	threshold voltage	$\left. \begin{array}{l} \text{slope resistance} \\ \text{for power loss calculation only} \end{array} \right\}$	$T_{VJ} = 175^\circ\text{C}$		0.52	V
$r_F$	slope resistance				6.5	mΩ
$R_{thJC}$	thermal resistance junction to case				0.55	K/W
$T_{VJ}$	virtual junction temperature		-55		175	°C
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		275	W
$I_{FSM}$	max. forward surge current	$t = 10\text{ ms}$ (50 Hz), sine	$T_{VJ} = 45^\circ\text{C}$		450	A
$C_J$	junction capacitance	$V_R = 24\text{V}; f = 1\text{ MHz}$	$T_{VJ} = 25^\circ\text{C}$	260		pF

Symbol	Definition	Conditions	Ratings			
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin <sup>1)</sup>			70	A
$R_{thCH}$	thermal resistance case to heatsink			0.25		K/W
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				6		g
$M_D$	mounting torque		0.8		1.2	Nm
$F_c$	mounting force with clip		20		120	N

<sup>1)</sup>  $I_{RMS}$  is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

### Product Marking

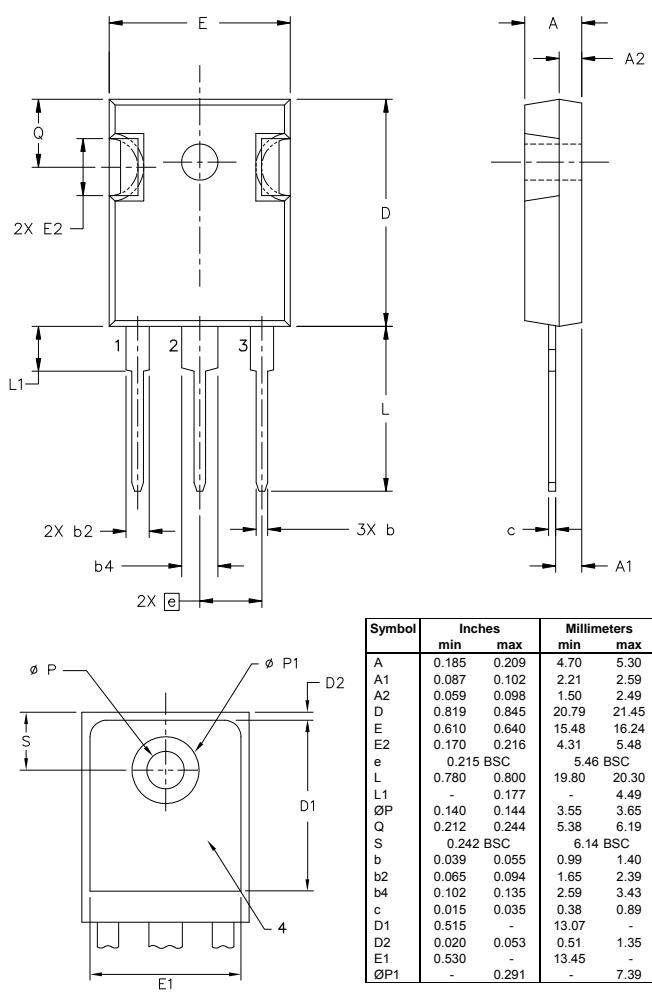


### Part number

D = Diode  
 S = Schottky Diode  
 A = low VF  
 90 = Current Rating [A]  
 C = Common Cathode  
 200 = Reverse Voltage [V]  
 HB = TO-247AD (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DSA 90 C 200 HB	DSA90C200HB	Tube	30	502854

## Outlines TO-247



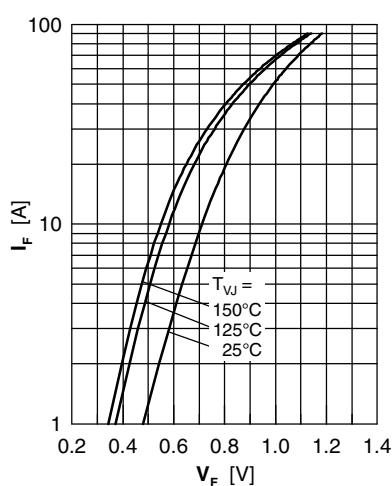


Fig. 1 Maximum forward voltage drop characteristics

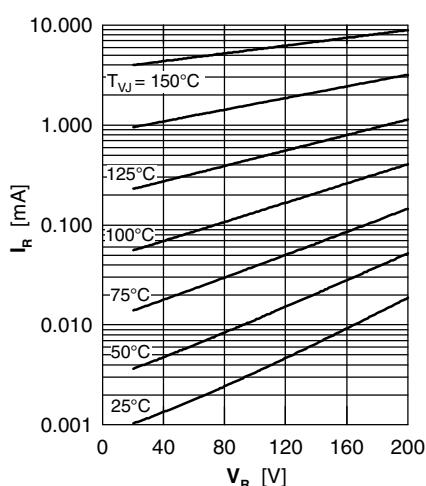


Fig. 2 Typ. reverse current  $I_R$  versus reverse voltage  $V_R$

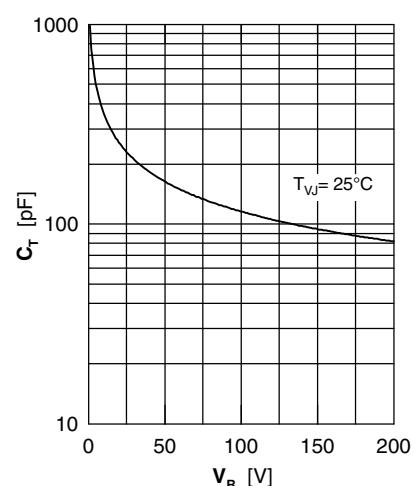


Fig. 3 Typ. junction capacitance  $C_T$  versus reverse voltage  $V_R$

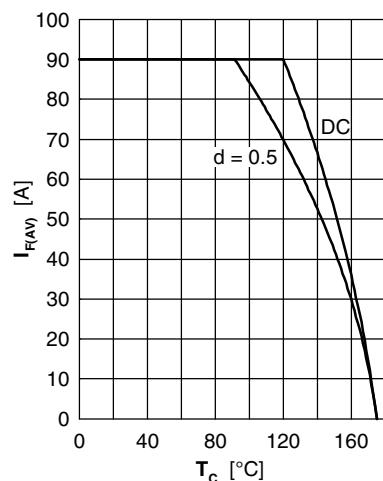


Fig. 4 Avg: forward current  $I_{F(AV)}$  versus case temperature  $T_c$

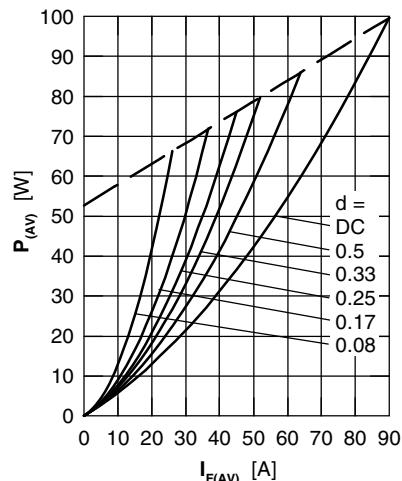


Fig. 5 Forward power loss characteristics

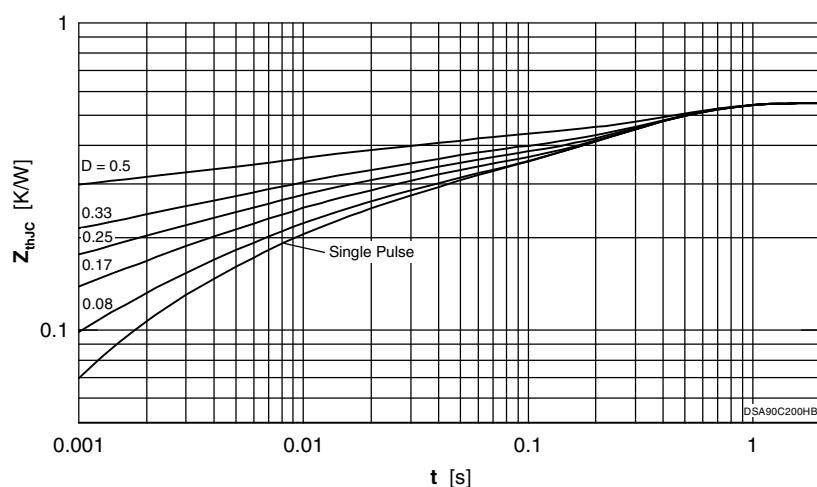


Fig. 6 Transient thermal impedance junction to case at various duty cycles